

MOSFET

OptiMOS[™]5 Power-Transistor, 150 V

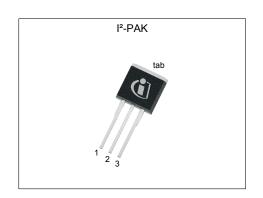
Features

Package

- Excellent gate charge x R_{DS(on)} product (FOM)
 Very low on-resistance R_{DS(on)}
 175 °C operating temperature
 Pb-free lead plating; RoHS compliant
 Qualified according to JEDEC¹⁾ for target application
 Ideal for high-frequency switching and synchronous rectification
 Halogen-free according to IEC61249-2-21



Parameter	Value	Unit					
V _{DS}	150	V					
R _{DS(on),max (TO262)}	5.1	mΩ					
I _D	120	A					











Type / Ordering Code	Package	Marking	Related Links
IPI051N15N5	PG-TO262-3	051N15N5	-

OptiMOS[™]5 Power-Transistor, 150 V



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OptiMOS[™]5 Power-Transistor, 150 V IPI051N15N5



1 Maximum ratings at T_A =25 °C, unless otherwise specified

Table 2 **Maximum ratings**

Davamatav	Cumb al	Values			11!4	Note / Took Condition	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Continuous drain current	I _D	-	-	120 115	А	T _C =25 °C T _C =100 °C	
Pulsed drain current ¹⁾	I _{D,pulse}	-	-	480	Α	T _C =25 °C	
Avalanche energy, single pulse ²⁾	E AS	-	-	230	mJ	I_D =100 A, R_{GS} =25 Ω	
Gate source voltage	V _{GS}	-20	-	20	V	-	
Power dissipation	P _{tot}	-	-	300	W	T _C =25 °C	
Operating and storage temperature	T _j , T _{stg}	-55	-	175	°C	IEC climatic category; DIN IEC 68-1: 55/175/56	

Thermal characteristics 2

Table 3 Thermal characteristics

Development	Cumbal	Values			11	Note / Took Condition	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Thermal resistance, junction - case	R _{thJC}	-	0.3	0.5	K/W	-	
Thermal resistance, junction - ambient, minimal footprint	R _{thJA}	-	-	62	K/W	-	

3 **Electrical characteristics**

Table 4 **Static characteristics**

Parameter	Cymbol		Values			Note / Test Condition	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Drain-source breakdown voltage	V _{(BR)DSS}	150	-	-	V	V _{GS} =0 V, I _D =1 mA	
Gate threshold voltage	$V_{\rm GS(th)}$	3.0	3.8	4.6	V	$V_{\rm DS}=V_{\rm GS},\ I_{\rm D}=264\ \mu {\rm A}$	
Zero gate voltage drain current	I _{DSS}	-	0.1 10	1 100	μA	V _{DS} =120 V, V _{GS} =0 V, T _j =25 °C V _{DS} =120 V, V _{GS} =0 V, T _j =125 °C	
Gate-source leakage current	I _{GSS}	-	1	100	nA	V _{GS} =20 V, V _{DS} =0 V	
Drain-source on-state resistance	R _{DS(on)}	-	4.0 4.3	5.1 5.7	mΩ	V _{GS} =10 V, I _D =60 A V _{GS} =8 V, I _D =30 A	
Gate resistance ³⁾	R _G	-	1.1	1.6	Ω	-	
Transconductance	g fs	59	117	-	S	$ V_{DS} > 2 I_D R_{DS(on)max}, I_D = 60 \text{ A}$	

See Diagram 3
 See Diagram 13
 Defined by design. Not subject to production test.

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Table 5 Dynamic characteristics

Paramatan.	Or made al		Values			Nata (Tant Oan dition	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Input capacitance ¹⁾	Ciss	-	6000	7800	pF	V _{GS} =0 V, V _{DS} =75 V, <i>f</i> =1 MHz	
Output capacitance ¹⁾	Coss	-	1500	1950	pF	V _{GS} =0 V, V _{DS} =75 V, <i>f</i> =1 MHz	
Reverse transfer capacitance ¹⁾	Crss	-	34	60	pF	V _{GS} =0 V, V _{DS} =75 V, <i>f</i> =1 MHz	
Turn-on delay time	$t_{\sf d(on)}$	-	19.6	-	ns	$V_{\rm DD}$ =75 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =60 A, $R_{\rm G,ext}$ =1.6 Ω	
Rise time	t _r	-	5.3	-	ns	$V_{\rm DD}$ =75 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =60 A, $R_{\rm G,ext}$ =1.6 Ω	
Turn-off delay time	$t_{ m d(off)}$	-	4.5	-	ns	$V_{\rm DD}$ =75 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =60 A, $R_{\rm G,ext}$ =1.6 Ω	
Fall time	t _f	-	37	-	ns	$V_{\rm DD}$ =75 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =60 A, $R_{\rm G,ext}$ =1.6 Ω	

Table 6 Gate charge characteristics²⁾

Domenator	Complete		Values			Nata / Tank Oam distant	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Gate to source charge	Q _{gs}	-	33	-	nC	$V_{\rm DD}$ =75 V, $I_{\rm D}$ =60 A, $V_{\rm GS}$ =0 to 10 V	
Gate to drain charge ¹⁾	Q _{gd}	-	16	24	nC	$V_{\rm DD}$ =75 V, $I_{\rm D}$ =60 A, $V_{\rm GS}$ =0 to 10 V	
Switching charge	Q _{sw}	-	31	-	nC	$V_{\rm DD}$ =75 V, $I_{\rm D}$ =60 A, $V_{\rm GS}$ =0 to 10 V	
Gate charge total ¹⁾	Q g	-	80	100	nC	$V_{\rm DD}$ =75 V, $I_{\rm D}$ =60 A, $V_{\rm GS}$ =0 to 10 V	
Gate plateau voltage	V _{plateau}	-	5.4	-	V	$V_{\rm DD}$ =75 V, $I_{\rm D}$ =60 A, $V_{\rm GS}$ =0 to 10 V	
Output charge ¹⁾	Qoss	-	225	299	nC	V _{DD} =75 V, V _{GS} =0 V	

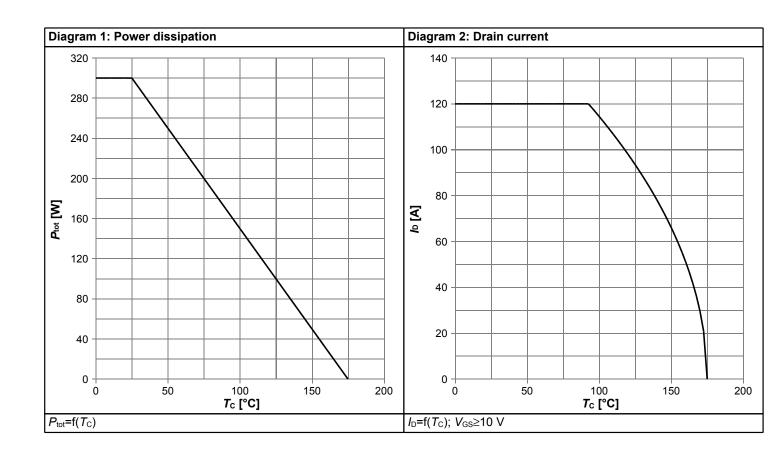
Table 7 Reverse diode

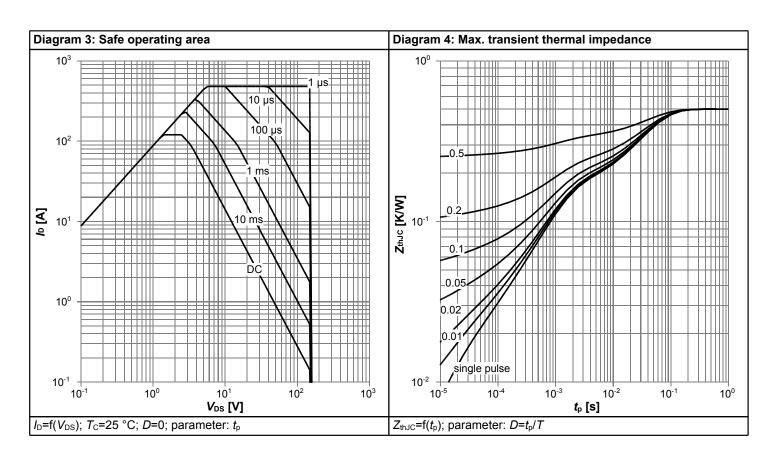
Dovomotor	Cumbal	Values			l lmit	Note / Tost Condition	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Diode continous forward current	Is	-	-	120	Α	T _C =25 °C	
Diode pulse current	I _{S,pulse}	-	-	480	Α	T _C =25 °C	
Diode forward voltage	$V_{ extsf{SD}}$	-	0.87	1.1	V	V _{GS} =0 V, I _F =60 A, T _j =25 °C	
Reverse recovery time ¹⁾	<i>t</i> _{rr}	-	72	144	ns	V _R =75 V, I _F =60 A, di _F /dt=100 A/μs	
Reverse recovery charge ¹⁾	Qrr	-	106	212	nC	V_R =75 V, I_F =60 A, di_F/dt =100 A/ μ s	

 $^{^{1)}}$ Defined by design. Not subject to production test. $^{2)}$ See "Gate charge waveforms" for parameter definition

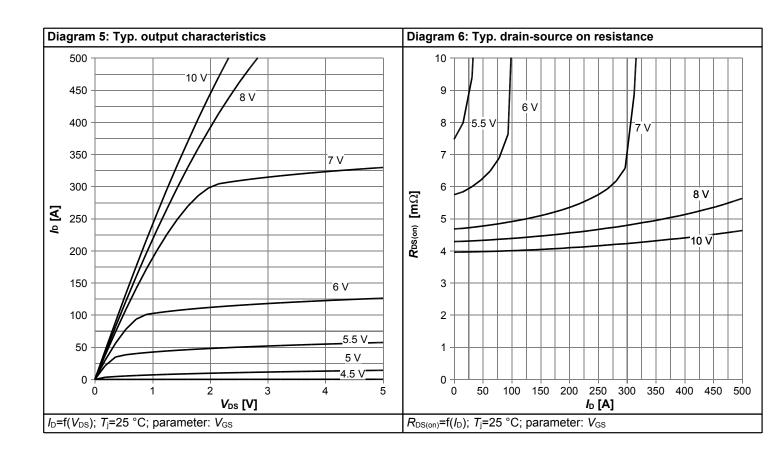


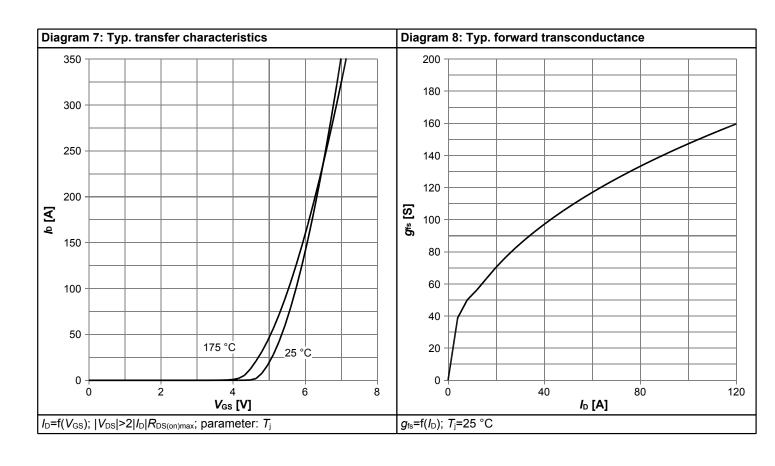
4 Electrical characteristics diagrams



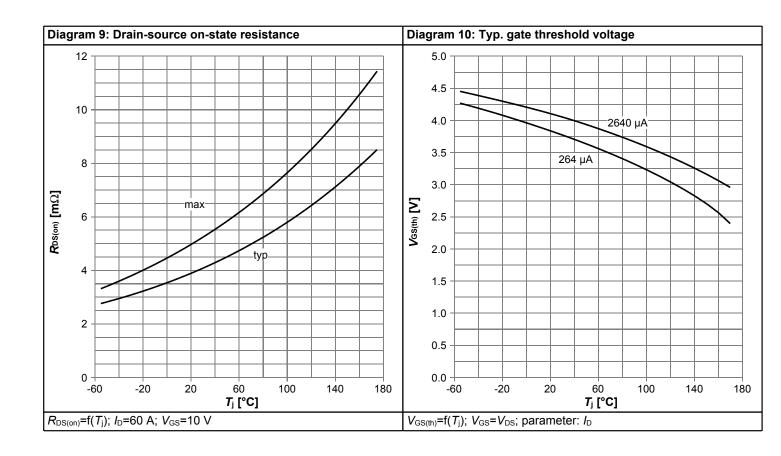


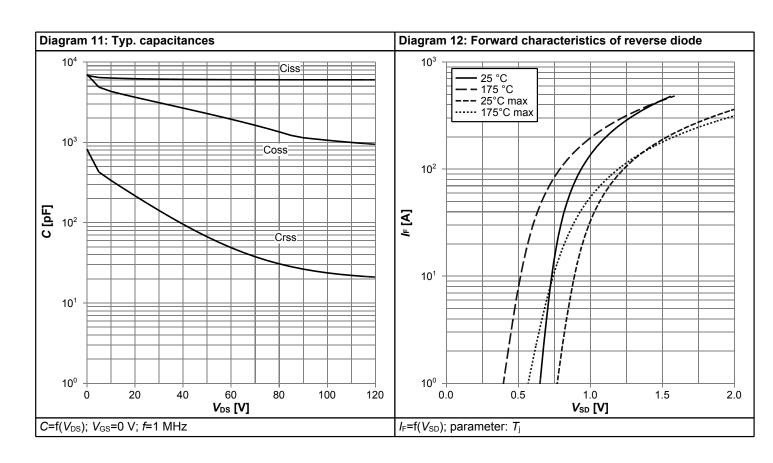




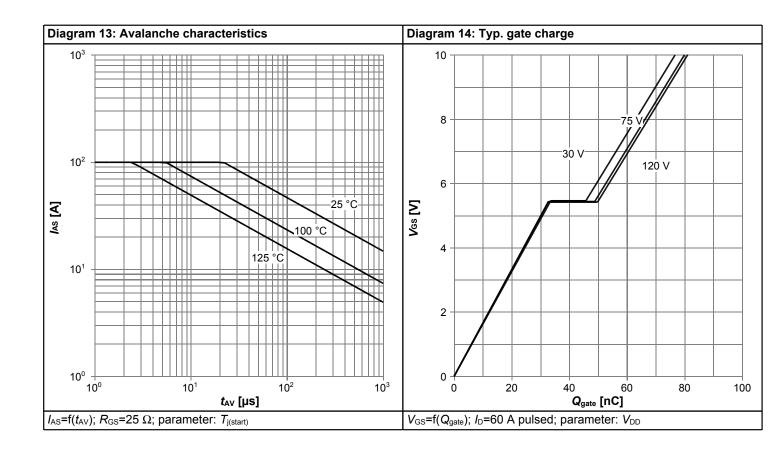


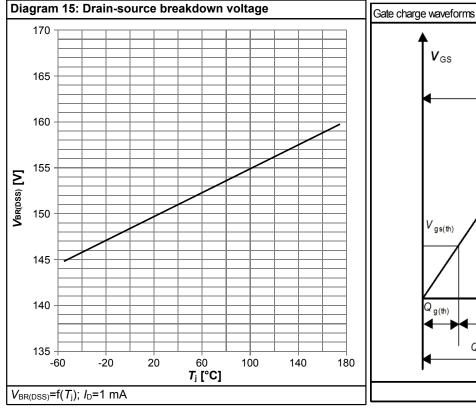


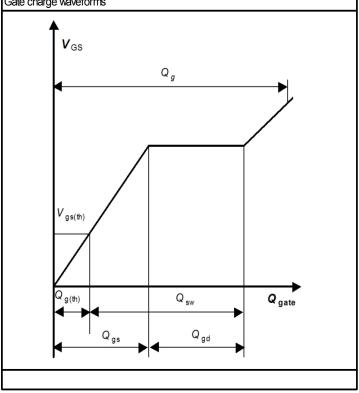






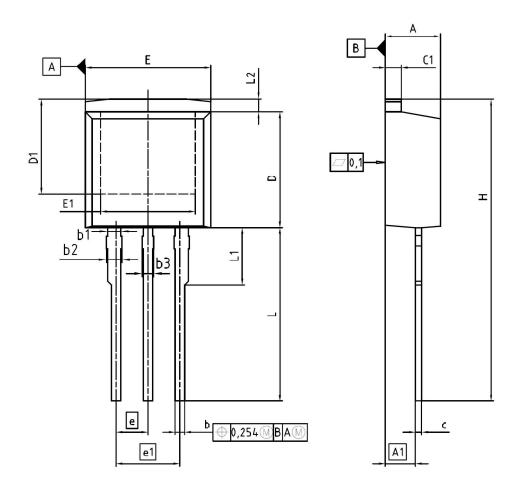








5 Package Outlines



DIM	MILLIM	ETERS	INCHES			
DIM	MIN	MAX	MIN	MAX		
Α	4.300	4.572	0.169	0.180		
A1	2.150	2.718	0.085	0.107		
b	0.650	0.864	0.026	0.034		
b1	0.950	1.093	0.037	0.043		
b2	0.950	1.400	0.037	0.055		
b3	0.650	1.118	0.026	0.044		
С	0.330	0.600	0.013	0.024		
c1	1.170	1.400	0.046	0.055		
D	8.509	9.450	0.335	0.372		
D1	6.900	-	0.272	-		
E	9.700	10.363	0.382	0.408		
E1	6.500	8.600	0.256	0.339		
е	2.	540	0.100			
e1	5.0	080	0.200			
N	3		3	3		
L	13.000	14.000	0.512	0.551		
L1	-	4.800	-	0.189		
L2	=	1.727	-	0.068		

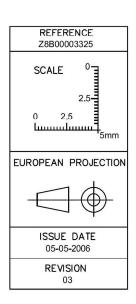


Figure 1 Outline PG-TO262-3, dimensions in mm/inches

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Revision History

IPI051N15N5

Revision: 2016-02-01, Rev. 2.0

Previous Revision

Revision	Date	Subjects (major changes since last revision)				
2.0	2016-02-01	Release of final version				

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